1500 Watt Mosorb[™] Zener Transient Voltage Suppressors

Unidirectional

Mosorb devices are designed to protect voltage sensitive components from high voltage, high-energy transients. They have excellent clamping capability, high surge capability, low zener impedance and fast response time. These devices are ON Semiconductor's exclusive, cost-effective, highly reliable Surmetic[™] axial leaded package and are ideally-suited for use in communication systems, numerical controls, process controls, medical equipment, business machines, power supplies and many other industrial/consumer applications, to protect CMOS, MOS and Bipolar integrated circuits.

Features

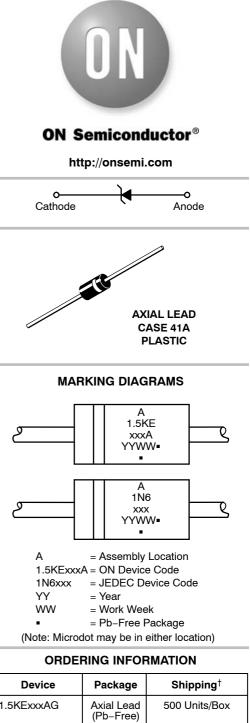
- Working Peak Reverse Voltage Range 5.8 V to 214 V
- Peak Power 1500 Watts @ 1 ms
- ESD Rating of Class 3 (>16 kV) per Human Body Model
- Maximum Clamp Voltage @ Peak Pulse Current
- Low Leakage < 5 µA Above 10 V
- UL 497B for Isolated Loop Circuit Protection
- Response Time is Typically < 1 ns
- Pb-Free Packages are Available*

Mechanical Characteristics

CASE: Void-free, transfer-molded, thermosetting plastic **FINISH:** All external surfaces are corrosion resistant and leads are readily solderable

MAXIMUM LEAD TEMPERATURE FOR SOLDERING PURPOSES:

260°C, 1/16 in from the case for 10 seconds **POLARITY:** Cathode indicated by polarity band **MOUNTING POSITION:** Any



Device	Package	Shipping [†]
1.5KExxxAG	Axial Lead (Pb-Free)	500 Units/Box
1.5KExxxARL4G	Axial Lead (Pb-Free)	1500/Tape & Reel
1N6xxxAG	Axial Lead (Pb-Free)	500 Units/Box
1N6xxxARL4G	Axial Lead (Pb-Free)	1500/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

Preferred devices are recommended choices for future use and best overall value.

MAXIMUM RATINGS

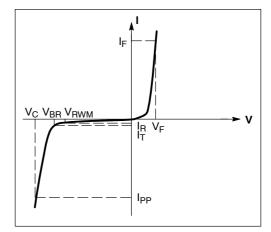
Rating	Symbol	Value	Unit
Peak Power Dissipation (Note 1) @ $T_L \le 25^{\circ}C$	P _{PK}	1500	W
Steady State Power Dissipation @ $T_L \le 25^{\circ}C$, Lead Length = 3/8 in Derated above $T_L = 50^{\circ}C$	P _D	5.0 50	W mW/°C
Thermal Resistance, Junction-to-Lead	R _{θJL}	20	°C/W
Forward Surge Current (Note 2) @ T _A = 25°C	I _{FSM}	200	А
Operating and Storage Temperature Range	T _J , T _{stg}	– 65 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Nonrepetitive current pulse per Figure 5 and derated above $T_A = 25^{\circ}C$ per Figure 2. 2. 1/2 sine wave (or equivalent square wave), PW = 8.3 ms, duty cycle = 4 pulses per minute maximum.

Symbol	Parameter					
I _{PP}	Maximum Reverse Peak Pulse Current					
V _C	Clamping Voltage @ I _{PP}					
V _{RWM}	Working Peak Reverse Voltage					
I _R	Maximum Reverse Leakage Current @ V _{RWM}					
V _{BR}	Breakdown Voltage @ I _T					
I _T Test Current						
ΘV _{BR} Maximum Temperature Coefficient of V _{BR}						
١ _F	Forward Current					
V _F	Forward Voltage @ I _F					

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted, V_F = 3.5 V Max., I_F (Note 3) = 100 A)



Uni-Directional TVS

		V		Breakdown Voltage			V _C @ I _{PP} (Note 7)			
JEDEC Device [†]		V _{RWM} (Note 5) I _F	I _R @ V _{RWM}	V _{BR} (Note 6) (Volts)		@ I _T	Vc	I _{PP}	ΘV _{BR}	
Device [†]	(Note 4)	(Volts)	(μΑ)	Min	Nom	Max	(mA)	(Volts)	(A)	(%/°C)
1.5KE6.8AG	1N6267AG	5.8	1000	6.45	6.8	7.14	10	10.5	143	0.057
1.5KE7.5AG	-	6.4	500	7.13	7.5	7.88	10	11.3	132	0.061
1.5KE8.2AG	1N6269AG	7.02	200	7.79	8.2	8.61	10	12.1	124	0.065
1.5KE9.1AG	-	7.78	50	8.65	9.1	9.55	1	13.4	112	0.068
1.5KE10AG	1N6271AG	8.55	10	9.5	10	10.5	1	14.5	103	0.073
1.5KE11AG	-	9.4	5	10.5	11	11.6	1	15.6	96	0.075
1.5KE12AG	-	10.2	5	11.4	12	12.6	1	16.7	90	0.078
1.5KE13AG	1N6274AG	11.1	5	12.4	13	13.7	1	18.2	82	0.081
1.5KE15AG	1N6275AG	12.8	5	14.3	15	15.8	1	21.2	71	0.084
1.5KE16A, G	1N6276AG	13.6	5	15.2	16	16.8	1	22.5	67	0.086
1.5KE18A, G	1N6277AG	15.3	5	17.1	18	18.9	1	25.2	59.5	0.088
1.5KE20AG	1N6278AG	17.1	5	19	20	21	1	27.7	54	0.09
_	1N6279AG	18.8	5	20.9	22	23.1	1	30.6	49	0.092
1.5KE24AG	1N6280AG	20.5	5	22.8	24	25.2	1	33.2	45	0.094
1.5KE27AG	1N6281AG	23.1	5	25.7	27	28.4	1	37.5	40	0.096
1.5KE30AG	1N6282AG	25.6	5	28.5	30	31.5	1	41.4	36	0.097
1.5KE33AG	1N6283AG	28.2	5	31.4	33	34.7	1	45.7	33	0.098
1.5KE36AG	1N6284AG	30.8	5	34.2	36	37.8	1	49.9	30	0.099
1.5KE39AG	1N6285AG	33.3	5	37.1	39	41	1	53.9	28	0.1
1.5KE43AG	1N6286AG	36.8	5	40.9	43	45.2	1	59.3	25.3	0.101
1.5KE47AG	1N6287AG	40.2	5	44.7	47	49.4	1	64.8	23.2	0.101
1.5KE51AG	1N6288A, G	43.6	5	48.5	51	53.6	1	70.1	21.4	0.102
1.5KE56AG	1N6289AG	47.8	5	<i>53.2</i>	56	58.8	1	77	19.5	0.103
1.5KE62AG	1N6290AG	53	5	58.9	62	65.1	1	85	17.7	0.104
1.5KE68AG	1N6291AG	58.1	5	64.6	68	71.4	1	92	16.3	0.104
1.5KE75AG	1N6292AG	64.1	5	71.3	75	78.8	1	103	14.6	0.105
1.5KE82A, G	-	70.1	5	77.9	82	86.1	1	113	13.3	0.105
1.5KE91AG	1N6294AG	77.8	5	86.5	91	95.5	1	125	12	0.106
_	1N6295AG	85.5	5	95	100	105	1	137	11	0.106

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted, V_F = 3.5 V Max. @ I_F (Note 3) = 100 A)

Devices listed in **bold**, italic are ON Semiconductor Preferred devices. Preferred devices are recommended choices for future use and best overall value.

3. 1/2 sine wave (or equivalent square wave), PW = 8.3 ms, duty cycle = 4 pulses per minute maximum.

4. Indicates JEDEC registered data

5. A transient suppressor is normally selected according to the maximum working peak reverse voltage (V_{RWM}), which should be equal to or 6. V_{BR} measured at pulse test current I_T at an ambient temperature of 25°C
7. Surge current waveform per Figure 5 and derate per Figures 1 and 2.

†The "G" suffix indicates Pb-Free package or Pb-Free packages are available.

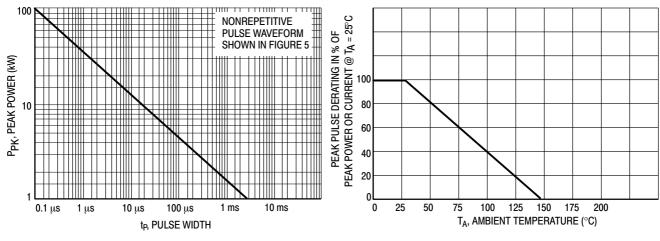


Figure 1. Pulse Rating Curve

Figure 2. Pulse Derating Curve

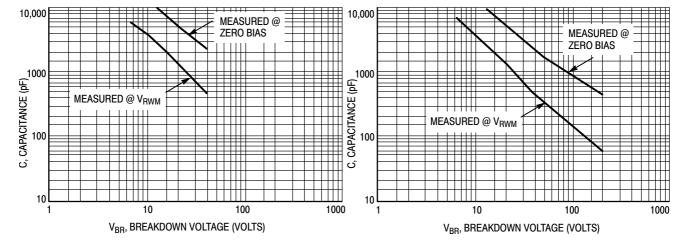
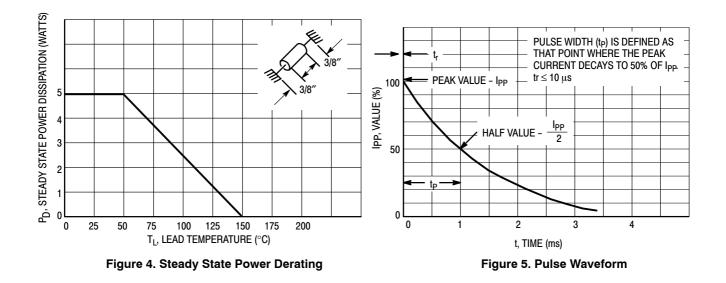
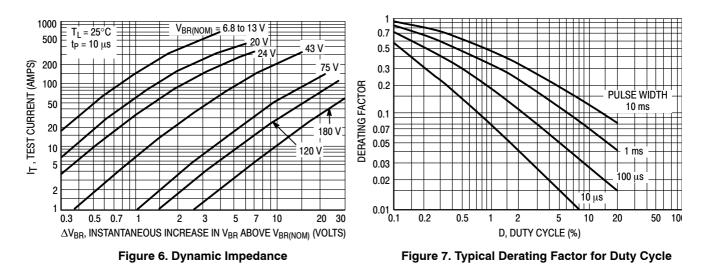


Figure 3. Capacitance versus Breakdown Voltage





APPLICATION NOTES

RESPONSE TIME

In most applications, the transient suppressor device is placed in parallel with the equipment or component to be protected. In this situation, there is a time delay associated with the capacitance of the device and an overshoot condition associated with the inductance of the device and the inductance of the connection method. The capacitance effect is of minor importance in the parallel protection scheme because it only produces a time delay in the transition from the operating voltage to the clamp voltage as shown in Figure 8.

The inductive effects in the device are due to actual turn-on time (time required for the device to go from zero current to full current) and lead inductance. This inductive effect produces an overshoot in the voltage across the equipment or component being protected as shown in Figure 9. Minimizing this overshoot is very important in the application, since the main purpose for adding a transient suppressor is to clamp voltage spikes. These devices have excellent response time, typically in the picosecond range and negligible inductance. However, external inductive effects could produce unacceptable overshoot. Proper circuit layout, minimum lead lengths and placing the suppressor device as close as possible to the equipment or components to be protected will minimize this overshoot.

Some input impedance represented by Z_{in} is essential to prevent overstress of the protection device. This impedance should be as high as possible, without restricting the circuit operation.

DUTY CYCLE DERATING

The data of Figure 1 applies for non-repetitive conditions and at a lead temperature of 25°C. If the duty cycle increases, the peak power must be reduced as indicated by the curves of Figure 7. Average power must be derated as the lead or ambient temperature rises above 25°C. The average power derating curve normally given on data sheets may be normalized and used for this purpose.

At first glance the derating curves of Figure 7 appear to be in error as the 10 ms pulse has a higher derating factor than the 10 μ s pulse. However, when the derating factor for a given pulse of Figure 7 is multiplied by the peak power value of Figure 1 for the same pulse, the results follow the expected trend.

TYPICAL PROTECTION CIRCUIT

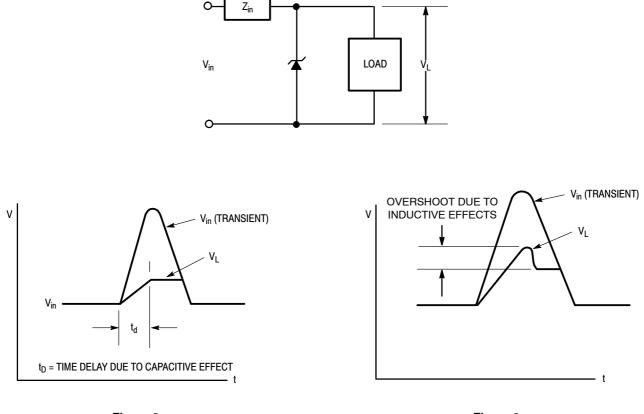


Figure 8.



UL RECOGNITION*

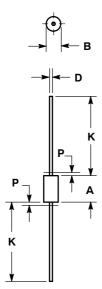
The entire series has *Underwriters Laboratory Recognition* for the classification of protectors (QVGQ2) under the UL standard for safety 497B and File #E210057. Many competitors only have one or two devices recognized or have recognition in a non-protective category. Some competitors have no recognition at all. With the UL497B recognition, our parts successfully passed several tests including Strike Voltage Breakdown test, Endurance Conditioning, Temperature test, Dielectric Voltage-Withstand test, Discharge test and several more.

Whereas, some competitors have only passed a flammability test for the package material, we have been recognized for much more to be included in their Protector category.

*Applies to 1.5KE6.8A thru 1.5KE250A

PACKAGE DIMENSIONS

MOSORB CASE 41A-04 ISSUE D



NOTES: 1. DIMENSIONING A

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH. 3. LEAD FINISH AND DIAMETER UNCONTROLLED IN DIMENSION P.
- 4. 041A-01 THRU 041A-03 OBSOLETE, NEW STANDARD 041A-04.

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.335	0.374	8.50	9.50	
В	0.189	0.209	4.80	5.30	
D	0.038	0.042	0.96	1.06	
K	1.000		25.40		
Р		0.050		1.27	

Mosorb and Surmetic are trademarks of Semiconductor Components Industries, LLC.

ON Semiconductor and use registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death agsociated with such unintended or unauthorized use payers that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunit//Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81–3–5773–3850 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for ESD Suppressors / TVS Diodes category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below :

60KS200C D12V0H1U2WS-7 D18V0L1B2LP-7B 82356050220 D5V0F4U5P5-7 D5V0M5U6V-7 NTE4902 P4KE27CA P6KE11CA P6KE39CA-TP P6KE8.2A SA110CA SA60CA SA64CA SMBJ12CATR SMBJ8.0A SMLJ30CA-TP ESD112-B1-02EL E6327 ESD119B1W01005E6327XTSA1 ESD5V0J4-TP ESD5V0L1B02VH6327XTSA1 ESD7451N2T5G 19180-510 CPDT-5V0USP-HF 3.0SMCJ33CA-F 3.0SMCJ36A-F HSPC16701B02TP D3V3Q1B2DLP3-7 D55V0M1B2WS-7 DESD5V0U1BL-7B DRTR5V0U4SL-7 SCM1293A-04SO ESD203-B1-02EL E6327 SM12-7 SMF8.0A-TP SMLJ45CA-TP CEN955 W/DATA 82350120560 82356240030 VESD12A1A-HD1-GS08 CPDUR5V0R-HF CPDUR24V-HF CPDQC5V0U-HF CPDQC5V0USP-HF CPDQC5V0-HF D1213A-01LP4-7B D1213A-02WL-7 ESDLIN1524BJ-HQ 5KP100A 5KP15A